09/832,884

11/10/2003

DOCKET NO.: L/M-102-DIV

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

ial No.: 09/832,884

Confirmation No.: 2718

Divisional of 09/321,565

Applicant: Steve M. Danziger, et al.

Art Unit: 2829

Filed: April 12, 2001

Examiner: Evan T. Pert

Docket No: L/M-102-DIV

Customer No: 28892

For: Method and Apparatus for Evaluating a Known Good Die Using
Both Wire Bond and Flip-Chip Interconnects

TRANSMITTAL

US Patent & Trademark Office
2011 South Clark Place
Customer Window, Mail Stop: Non Fee Amendment
Crystal Plaza Two, Lobby, Room 1803
Arlington, VA 22202

Sir:	TRANSMITTED HEREWITH	H IS									
,	A RESPONSE,	X AN AMENDMENT,	AN AMENDMENT AFTER FINAL								
IN THE ABOVE-IDENTIFIED APPLICATION.											
	Small entity status of	of this application under	37 CFR §1.9(f) is established								
	by a verified stateme	ent under 37 CFR §1.27	previously submitted.								
			submitted herewith.								
x	No additional fee is	required, as shown below.									

CLAIMS PEND	CLAIMS PREVIOUSLY PAID		NEW CLAIMS EXTRA		ADDITIONAL FEES				
AFTER AMENDMENT					SMALL ENTITY		OTHER THAN SMALL ENTITY		
TOTAL	6	MINUS	20	=	0	x\$9=	0.00	x\$18=	0.00
INDEP	1	MINUS	3	=	0	x42=	0.00	x\$84=	0.00
NEW MULTIPLE DEPENDENT CLAIMS 0						x\$140=	0.00	x\$280=	0.00
AND CLAIMS DEPENDENT THEREON					0	x\$140=	0.00	x\$280=	0.00
TOTAL ADDITIONAL FEE						0.00		0.00	

This amount is believed to be correct, however, the Commissioner is hereby authorized to charge any deficiency or credit any overpayment to Deposit Account No. 19-2816. This authorization applies to both filing fees under 37 CFR §1.16 and processing fees (such as extension of time) under 37 CFR §1.17. A duplicate copy of this transmittal is attached.

Respectfully Submitted,

Registration No. 24,962

Date: November 10, 2003

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RRS/bam